TTORNEY)

As an inventor named below or on any attack

ontinuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD OF LOCATING CONDUCTIVE SPHERES UTILIZING SCREEN AND HOPPER OF SOLDER BALLS, the specification of which (check one):

is attached hereto.			
🛘 was filed onas	United States application serial no	and was amended on	
□ was filed onas	PCT international application no.	and was amended under PCT Article 19	on
I hereby state that I have reviewe referred to above.	ed and understand the contents of the abo	ve-identified specification, including the claims	, as amended by any amendment
I acknowledge the duty to disclos matter claimed in this application, as	e to the U.S. Patent and Trademark Office materiality" is defined in Title 37, Co.	ce all information known to me to be material de of Federal Regulations § 1.56.	to the patentability of the subject
certificate or § 365(a) of any PCT in attached continuation page and have	iternational application(s) designating at l also identified below and on any attached designating at least one country other the	e, § 119(a)-(d) or § 365(b) of any foreign appleast one country other than the United States of continuation page any foreign application for an the United States of America having a filing	f America listed below and on any
Prior foreign/PCT application(s):			
			Priority Claimed
(number)	(coun	try) (day/month/yea	ar filed) Yes No
(number)	(coun	try) (day/month/yea	ar filed) Yes No
តុំpplication is not disclosed in any suctified duty to disclose to the U.S. Paten Regulations § 1.56 which became ave	ch prior application in the manner provice and Trademark Office all information lated between the filing date of such properties.	ntinuation page and, insofar as the subject matt- led by the first paragraph of Title 35, United St known to me to be material to patentability as of ior application and the national or PCT internation	tates Code, § 112, I acknowledge defined in Title 37, Code of Federal tional filing date of this application:
(application serial no.)	(filing date)	(status - pending, pa	tented or abandoned)
[] (application serial no.)	(filing date)	(status - pending, pa	tented or abandoned)
Į.	the benefit under Title 35, United States	Code, § 119(e) of any United States provisions	ıl application(s) listed below:
(provisional application no.)	(filing date)		
(provisional application no.)	(filing date)		
(provisional application no.)	(filing date)	- 	
I hereby appoint the following Reg connected therewith:	gistered Practitioners to prosecute this ap	plication and to transact all business in the Pate	ent and Trademark Office
David V. Trask, Reg. No. 22,012 Laurence B. Bond, Reg. No. 30,5 Allen C. Turner, Reg. No. 33,041 Robert G. Winkle, Reg. No. 37,4 Brick G. Power, Reg. No. 38,581 Lia M. Pappas, Reg. No. 34,095	Joseph A. Walkowski, Reg. Kent S. Burningham, Reg.	No. 28,765 James R. Duzan, Reg. No. 30,453 Julie K. Morriss, Reg. No. 39,295 Edgar R. Cataxinos, Reg	No. 28,393 No. 33,263 g. No. 39,931
Address all correspondence to:	James R. Duzan, telephone no. (801 TRASK, BRITT & ROSSA P.O. BOX 2550 Salt Lake City, Utah 84110) 532-1922.	

or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Full name of first joint inventor: Chad A. Cobbley Inventor's signature

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment,

Residence: Boise, Idaho

Citizenship: U.S.A.

Post Office Address: 608 Boise Hills Drive, Boise, ID 83702

Invention title: METHOD OF LOCATING CONDUCTIVE SPHERES UTILIZING SCREEN AND HOPPER OF SOLDER BALLS

Inventor name(s) appearing on first declaration page: Chad A. Cobbley

Additional original, first and joint inventor(s):

Full name of second joint inventor: Michael B. Ball Inventor's signature	Date 9/23/98
Residence: Boise, ID	
Citizenship: U.S.A.	• •
Post Office Address: 8630 Pembrook Drive, Boise, ID 83704	
Full name of third joint inventor: Marjorie L. Waddel ()	Date <u>9-23-98</u>
Residence: Boise, Idaho	

Citizenship: U.S.A.
Post Office Address: 7903 W. Bayhill Ct., Boise, ID 83704